

Product Manual

Momentus_{5400.3}

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One gigabyte, or GB, equals one billion bytes and one terabyte, or TB, equals one trillion bytes when referring to hard drive capacity. Accessible capacity may vary depending on operating environment and formatting. Quantitative usage examples for various applications are for illustrative purposes. Actual quantities will vary based on various factors, including file size, file format, features and application software. Seagate reserves the right to change, without notice, product offerings or specifications.

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1.0 Introduction

This manual describes the functional, mechanical and interface specifications for the following Seagate® Momentus®5400.3 drives:

- ST9160821A
- ST9120822A
- ST9100828A
- ST980815A
- ST960815A
- ST940815A

These drives provide the following key features:

- 5,400-RPM spindle speed.
- 8-Mbyte buffer.
- Quiet operation. Fluid Dynamic Bearing (FDB) motor.
- High instantaneous (burst) data transfer rates (up to 100 Mbytes per second) using Ultra DMA mode 5.
- · Tunneling Magnetoresistive (TMR) recording heads. .
- State-of-the-art cache and on-the-fly error-correction algorithms.
- Full-track multiple-sector transfer capability without local processor intervention.
- 900 Gs nonoperating shock and 350 Gs operating shock.
- SeaTools™ diagnostic software performs a drive self-test that eliminates unnecessary drive returns.
- The 3D Defense System[™], which includes Drive Defense, Data Defense, and Diagnostic Defense, offers the
 industry's most comprehensive protection for disc drives.
- Support for S.M.A.R.T. drive monitoring and reporting.
- Support for Read Multiple and Write Multiple commands.
- Support for autodetection of master/slave drives using cable select (CSEL).

2.0 Drive specifications

Unless otherwise noted, all specifications are measured under ambient conditions, at 25°C, and nominal power. For convenience, the phrases *the drive* and *this drive* are used throughout this manual to indicate ST9160821A, ST9120822A, ST9100828A, ST980815A, ST960815A, and ST940815A model drives.

2.1 Specification summary

The specifications listed in this table are for quick reference. For details on specification measurement or definition, see the appropriate section of this manual.

Table 1: Specifications for 160 and 120 Gbyte models

Drive specification	ST9160821A	ST9120822A	
Formatted Gbytes (512 bytes/sector)*	160	120	
Guaranteed sectors	312,581,808	234,441,648	
Bytes per sector	512		
Physical read/write heads	4	3	
Discs	2		
Cache (Mbytes)	8		
Recording density, BPI (bits/inch typical)	835k		
Track density, TPI (tracks/inch typical)	150k		
Areal density (Gbits/inch ² max)	132		
Spindle speed (RPM)	5,400		
Internal data transfer rate (Mbits/sec max)	352		
I/O data-transfer rate (Mbytes/sec max)	100		
ATA data-transfer modes supported	PIO modes 0–4 Multiword DMA modes Ultra DMA modes 0–5	0–2	
Height	9.5 +/-0.2 mm (0.374 +/	/008 inches)	
Width	69.85 +/-0.25 mm (2.75	60 +/-0.010 inches)	
Length	100.50 +/-0.25 mm (3.9	957 +/-0.010 inches)	
Weight (typical)	102 grams (0.22 lb)		
Average latency (msec)	5.6		
Power-on to ready (sec typical)	3.0		
Standby to ready (sec typical)	3.0		
Track-to-track seek time (msec typical)	1.0 (read), 1.5 (write)	1.0 (read), 1.5 (write)	
Average random seek , write (msec typical)	13.0	13.0	
Average random seek, read (msec typical)	11.0	11.0	
Average random seek, (msec typical)	12.5	12.5	
Full-stroke seek (msec)	22 (typical); 24 (max)	22 (typical); 24 (max)	
Startup current 5V (typical)	1.0 amps	1.0 amps	

Table 1: Specifications for 160 and 120 Gbyte models

Drive specification	ST9160821A	ST9120822A
Seek power (typical)	2.0 watts	
Read/write power (typical)	Read: 2.0 watts; Write: 1.8 wa	tts
Idle mode (typical, low power)	0.8 watts	
Standby mode	0.2 watts (typical)***	
Sleep mode	0.2 watts (typical)***	
Voltage tolerance (including noise)	5V ± 5%	
Ambient temperature	0° to 60°C (operating), -40° to	70°C (nonoperating)
Temperature gradient (°C per hour max, noncondensing)	20°C (operating) 30°C (nonoperating)	
Relative humidity (noncondensing)	5% to 90% (operating) 5% to 95% (nonoperating)	
Relative humidity gradient	30% per hour max	
Wet bulb temperature (°C max)	30°C (operating) 38°C (nonoperating)	
Altitude, operating	-304.8 m to 3,048 m (-1000 ft	t to 10,000 ft)
Altitude, nonoperating (below mean sea level)	-304.8 m to 12,192 m (-1,000) ft to 40,000 ft) max
Shock, operating (Gs max at 2 msec)	350	
Shock, nonoperating (Gs max at 2 msec)	800	
Shock, nonoperating (Gs max at 1 msec)	900	
Shock, nonoperating (Gs max at 0.5 msec)	400	
Vibration, operating (max displacement may apply below 10 hz)	1.0 Gs (0 to peak, 5-500 Hz)	
Vibration, nonoperating (max displacement may apply below 22 hz)	5.0 Gs (0 to peak, 5-500 Hz)	
Drive acoustics, sound power (bels), 2 disc		
Idle**	2.4 (typical) 2.6 (max)	
Performance seek	3.0 (typical) 3.2 (max)	
Nonrecoverable read errors	1 per 10 ¹⁴ bits read	
Annualized Failure Rate (AFR)	<0.60%	
Load/Unload (U/UL) cycles		
25°C, 50% relative humidity	600,000 software-controlled po 20,000 hard power on/off cycle	
32°C, 80% relative humidity 5°C, 80% relative humidity 5°C, 20% relative humidity 60°C, 20% relative humidity	600,000 software-controlled po 20,000 hard power on/off cycle	
Warranty	be asked to provide the drive	g web page: vice/ /erify Your Warranty" link. You will serial number, model number (or urchase. The system will display

^{*}One Gbyte equals one billion bytes when referring to hard drive capacity. Accessible capacity may vary depending on operating environment and formatting.

^{**}During periods of drive idle, some offline activity may occur, according to the S.M.A.R.T. specification, which may increase acoustic and power to operational levels.

^{***}Typical notebooks will pull power to the drive when entering S3 and S4; while in the S3 and S4 states, drive sleep and drive standby modes will not contribute to battery power consumption.

Table 1: Specifications for 100 and 80 Gbyte models

Drive specification	ST9100828A	ST980815A	
Formatted Gbytes (512 bytes/sector)*	100	80	
Guaranteed sectors	195,371,568	156,301,488	
Bytes per sector	512	-	
Physical read/write heads	3	2	
Discs	2	1	
Cache (Mbytes)	8	-	
Recording density, BPI (bits/inch typical)	835k		
Track density, TPI (tracks/inch typical)	150k		
Areal density (Gbits/inch ² max)	132		
Spindle speed (RPM)	5,400		
Internal data transfer rate (Mbits/sec max)	352		
I/O data-transfer rate (Mbytes/sec max)	100		
ATA data-transfer modes supported	PIO modes 0-4 Multiword DMA modes 0 Ultra DMA modes 0-5)–2	
Height	9.5 +/-0.2 mm (0.374 +/-	008 inches)	
Width	69.85 +/-0.25 mm (2.750	0 +/-0.010 inches)	
Length	100.50 +/-0.25 mm (3.95	57 +/-0.010 inches)	
Weight (typical)	102 grams (0.22 lb)	98 grams (0.216 lb)	
Average latency (msec)	5.6	<u>'</u>	
Power-on to ready (sec typical)	3.0		
Standby to ready (sec typical)	3.0		
Track-to-track seek time (msec typical)	1.0 (read), 1.5 (write)		
Average random seek , write (msec typical)	13.0		
Average random seek, read (msec typical)	11.0		
Average random seek, (msec typical)	12.5		
Full-stroke seek (msec)	22 (typical); 24 (max)		
Startup current 5V (typical)	1.0 amps		
Seek power (typical)	2.0 watts		
Read/write power (typical)	Read: 2.0 watts; Write: 1	1.8 watts	
Idle mode (typical, low power)	0.8 watts		
Standby mode	0.2 watts (typical)***		
Sleep mode	0.2 watts (typical)***		
Voltage tolerance (including noise)	5V ± 5%		
Ambient temperature	0° to 60°C (operating), -	-40° to 70°C (nonoperating)	
Temperature gradient (°C per hour max, noncondensing)	20°C (operating) 30°C (nonoperating)		
Relative humidity (noncondensing)	5% to 90% (operating) 5% to 95% (nonoperating)	ng)	
Relative humidity gradient	30% per hour max		
Wet bulb temperature (°C max)	30°C (operating) 38°C (nonoperating)		
Altitude, operating	-304.8 m to 3,048 m (-1	-304.8 m to 3,048 m (-1000 ft to 10,000 ft)	
Altitude, nonoperating (below mean sea level)	-304.8 m to 12,192 m (-	-1,000 ft to 40,000 ft) max	
Shock, operating (Gs max at 2 msec)	350		
Shock, nonoperating (Gs max at 2 msec)	800		

Table 1: Specifications for 100 and 80 Gbyte models

Drive specification	ST9100828A	ST980815A	
Shock, nonoperating (Gs max at 1 msec)	900		
Shock, nonoperating (Gs max at 0.5 msec)	400		
Vibration, operating (max displacement may apply below 10 hz)	1.0 Gs (0 to peak, 5–500 H	1.0 Gs (0 to peak, 5–500 Hz)	
Vibration, nonoperating (max displacement may apply below 22 hz)	5.0 Gs (0 to peak, 5–500 H	Hz)	
Drive acoustics, sound power (bels), 2 disc			
ldle**	2.4 (typical) 2.6 (max)		
Performance seek	2.9 (typical) 3.1 (max)		
Nonrecoverable read errors	1 per 10 ¹⁴ bits read		
Annualized Failure Rate (AFR)	0.60%		
Load/Unload (U/UL) cycles			
25°C, 50% relative humidity	600,000 software-controlle 20,000 hard power on/off c		
32°C, 80% relative humidity 5°C, 80% relative humidity 5°C, 20% relative humidity 60°C, 20% relative humidity	600,000 software-controlle 20,000 hard power on/off of		
Warranty	to access the following wel www.seagate.com/support From this page, click on the be asked to provide the dri	for a specific drive, use a web browser b page: //service/ e "Verify Your Warranty" link. You will ive serial number, model number (or purchase. The system will display	

^{*}One Gbyte equals one billion bytes when referring to hard drive capacity. Accessible capacity may vary depending on operating environment and formatting.

^{**}During periods of drive idle, some offline activity may occur, according to the S.M.A.R.T. specification, which may increase acoustic and power to operational levels.

^{***}Typical notebooks will pull power to the drive when entering S3 and S4; while in the S3 and S4 states, drive sleep and drive standby modes will not contribute to battery power consumption.

Table 1: Specifications for 60 and 40 Gbyte models

Drive specification	ST960815A	ST940815A	
Formatted Gbytes (512 bytes/sector)*	60	40	
Guaranteed sectors	117,410,240	78,140,160	
Bytes per sector	512	-	
Physical read/write heads	2	1	
Discs	1	-	
Cache (Mbytes)	8		
Recording density, BPI (bits/inch typical)	835k		
Track density, TPI (tracks/inch typical)	150k		
Areal density (Gbits/inch ² max)	132		
Spindle speed (RPM)	5,400		
Internal data transfer rate (Mbits/sec max)	352		
I/O data-transfer rate (Mbytes/sec max)	100		
ATA data-transfer modes supported	PIO modes 0–4 Multiword DMA modes Ultra DMA modes 0–5	s 0–2	
Height	9.5 +/-0.2 mm (0.374 +	-/008 inches)	
Width	69.85 +/-0.25 mm (2.7	50 +/-0.010 inches)	
Length	100.50 +/-0.25 mm (3.	957 +/-0.010 inches)	
Weight (typical)	98 grams (0.216 lb)		
Average latency (msec)	5.6		
Power-on to ready (sec typical)	3.0		
Standby to ready (sec typical)	3.0		
Track-to-track seek time (msec typical)	1.0 (read), 1.5 (write)		
Average random seek , write (msec typical)	13.0		
Average random seek, read (msec typical)	11.0		
Average random seek, (msec typical)	12.5		
Full-stroke seek (msec)	22 (typical); 24 (max)		
Startup current 5V (typical)	1.0 amps		
Seek power (typical)	2.0 watts		
Read/write power (typical)	Read: 2.0 watts; Write	: 1.8 watts	
Idle mode (typical, low power)	0.8 watts	0.8 watts	
Standby mode	0.2 watts (typical)***		
Sleep mode	0.2 watts (typical)***		
Voltage tolerance (including noise)	5V ± 5%		
Ambient temperature	0° to 60°C (operating),	-32° to 70°C (nonoperating)	
Temperature gradient (°C per hour max, noncondensing)	20°C (operating) 30°C (nonoperating)		
Relative humidity (noncondensing)	5% to 90% (operating) 5% to 95% (nonoperat		
Relative humidity gradient	30% per hour max		
Wet bulb temperature (°C max)	30°C (operating) 38°C (nonoperating)		
Altitude, operating	-304.8 m to 3,048 m (-	-304.8 m to 3,048 m (-1000 ft to 10,000 ft)	
Altitude, nonoperating (below mean sea level)	-304.8 m to 12,192 m	-304.8 m to 12,192 m (-1,000 ft to 40,000 ft) max	
Shock, operating (Gs max at 2 msec)	350	350	
Shock, nonoperating (Gs max at 2 msec)	800	800	

Table 1: Specifications for 60 and 40 Gbyte models

Drive specification	ST960815A	ST940815A
Shock, nonoperating (Gs max at 1 msec)	900	
Shock, nonoperating (Gs max at 0.5 msec)	400	
Vibration, operating (max displacement may apply below 10 hz)	1.0 Gs (0 to peak, 5–50	00 Hz)
Vibration, nonoperating (max displacement may apply below 22 hz)	5.0 Gs (0 to peak, 5–50	00 Hz)
Drive acoustics, sound power (bels), 2 disc		
Idle**	2.4 (typical) 2.6 (max)	
Performance seek	2.9 (typical) 3.1 (max)	
Nonrecoverable read errors	1 per 10 ¹⁴ bits read	
Annualized Failure Rate (AFR)	<0.60%	
Load/Unload (U/UL) cycles		
25°C, 50% relative humidity	600,000 software-contr 20,000 hard power on/o	olled power on/off cycles off cycles
32°C, 80% relative humidity 5°C, 80% relative humidity 5°C, 20% relative humidity 60°C, 20% relative humidity	600,000 software-control 20,000 hard power on/o	olled power on/off cycles off cycles
Warranty	browser to access the f www.seagate.com/supp From this page, click or will be asked to provide ber (or part number) an	nty for a specific drive, use a web following web page:

^{*}One Gbyte equals one billion bytes when referring to hard drive capacity. Accessible capacity may vary depending on operating environment and formatting.

^{**}During periods of drive idle, some offline activity may occur, according to the S.M.A.R.T. specification, which may increase acoustic and power to operational levels.

^{***}Typical notebooks will pull power to the drive when entering S3 and S4; while in the S3 and S4 states, drive sleep and drive standby modes will not contribute to battery power consumption.

2.2 Formatted capacity

Model	Formatted capacity*	Guaranteed sectors	Bytes per sector
ST9160821A	160 Gbytes	312,581,808	512
ST9120822A	120 Gbytes	234,441,648	512
ST9100828A	100 Gbytes	195,371,568	512
ST980815A	80 Gbytes	156,301,488	512
ST960815A	60 Gbytes	117,410,240	512
ST940815A	40 Gbytes	78,140,160	512

^{*}One Gbyte equals one billion bytes when referring to hard drive capacity. Accessible capacity may vary depending on operating environment and formatting.

2.3 Default logical geometry

Cylinders	Read/write heads	Sectors per track
16,383	16	63

LBA mode

When addressing these drives in LBA mode, all blocks (sectors) are consecutively numbered from 0 to n–1, where n is the number of guaranteed sectors as defined above.

2.4 Physical organization

Model	Read/write heads	Number of discs
ST9160821A	4	2
ST9120822A	3	2
ST9100828A	3	2
ST980815A	2	1
ST960815A	2	1
ST940815A	1	1

2.5 Recording and interface technology

Technology	Specification
Interface	Parallel ATA
Recording method	Perpendicular
Recording density BPI (bits/inch typical)	835k
Track density TPI (tracks/inch typical)	150k
Areal density (Gbits/inch ² max)	132
Spindle speed (RPM) (± 0.2%)	5,400
Internal data-transfer rate OD (Mbits/sec max)	352
I/O data-transfer rate (Mbytes/sec max)	100 (Ultra DMA mode 5)
Interleave	1:1
Cache buffer	8 Mbytes (8,192 kbytes)

2.6 Physical characteristics

Height	(mm) (inches)	9.5 +/-0.2 0.374 +/-0.008
Width	(mm) (inches)	69.85 +/-0.25 2.750 +/-0.010
Length	(mm) (inches)	100.50 +/-0.25 3.957 +/-0.010
Typical weight		
	ST9160821A ST9120822A ST9100828A	102 grams 0.22 pounds
	ST980815A ST960815A ST940815A	98 grams 0.216 pounds

2.7 Seek time

Seek measurements are taken with nominal power at 25°C ambient temperature. All times are measured using drive diagnostics. The specifications below are defined as follows:

- Track-to-track seek time is an average of all possible single-track seeks in both directions.
- Average seek time is a true statistical random average of at least 5,000 measurements of seeks between random tracks, less overhead.

Typical seek times (msec)*	Read	Write
Track-to-track	1.0	1.5
Average	11.0	13.0
Full-stroke	22.0	24.0
Average latency	5.56	5.56

^{*}Measured in performance mode

Note. These drives are designed to consistently meet the seek times represented in this manual. Physical seeks, regardless of mode (such as track-to-track and average), are expected to meet or exceed the noted values. However, due to the manner in which these drives are formatted, benchmark tests that include command overhead or measure logical seeks may produce results that vary from these specifications.

2.8 Time to ready

Time to ready	Typical	Max @ 25°C
Power-on to Ready (sec)	3.0	8.0
Standby to Ready (sec)	3.0	8.0

2.9 Power specifications

The drive receives DC power (+5V) through the interface connector.

2.9.1 Power consumption

Power requirements for the drives are listed in the table on page 12. Typical power measurements are based on an average of drives tested, under nominal conditions, at 25°C ambient temperature.

Spinup power

Spinup power is measured from the time of power-on to the time that the drive spindle reaches operating speed.

Seek mode

During seek mode, the read/write actuator arm moves toward a specific position on the disc surface and does not execute a read or write operation. Servo electronics are active. Seek mode power is measured based on three random seek operations every 100 msecs. This mode is not typical.

Read/write power and current

Read/write power is measured with the heads on track, based on three 63 sector read or write operations every 100 msecs.

Idle mode power*

Idle mode power is measured with the drive up to speed, with servo electronics active and with the heads in a random track location.

· Standby mode

During Standby mode, the drive accepts commands, but the drive is not spinning, and the servo and read/write electronics are in power-down model

Table 2: DC power for 2 disk models

Power dissipation	+5V average (25° C)
Spinup (typical)	1.0 amps
Seek	2.0 watts
Read	2.0 watts
Write	1.8 watts
Idle, performance	1.7 watts
Idle, active*	0.99 watts
Idle, low power mode*	0.8 watts
Standby	0.2 watts
Sleep	0.2 watts

^{*}During periods of drive idle, some offline activity may occur according to the S.M.A.R.T. specification, which may increase acoustic and power to operational levels.

2.9.1.1 Typical current profile

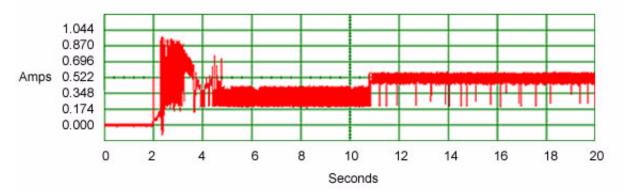


Figure 4. Typical 5V startup and operation current profile

2.9.2 Conducted noise

Input noise ripple is measured at the host system power supply across an equivalent 15-ohm resistive load on the +5 volt line.

Using 5-volt power, the drive is expected to operate with a maximum of 100 mV peak-to-peak square-wave injected noise at up to 10 MHz.

Note. Equivalent resistance is calculated by dividing the nominal voltage by the typical RMS read/write current.

2.9.3 Voltage tolerance

Voltage tolerance (including noise):

 $5V \pm 5\%$

2.9.4 Power-management modes

The drive provides programmable power management to provide greater energy efficiency. In most systems, you can control power management through the system setup program. The drive features the following power-management modes:

Table 3: Power management modes

Power modes	Heads	Spindle	Buffer
Active (operating)	Tracking	Rotating	Full power
Idle, performance	Tracking	Rotating	Self refresh—low power
Idle, active	Floating	Rotating	Self refresh—low power
Idle, low power	Parked	Rotating	Self refresh—low power
Standby	Parked	Stopped	Self refresh—low power
Sleep	Parked	Stopped	Self refresh—low power

Active mode

The drive is in Active mode during the read/write and seek operations.

Idle mode

The buffer remains enabled in performance mode, and the drive accepts all commands and returns to Active mode any time disc access is necessary.

· Standby mode

The drive enters Standby mode when the host sends a Standby Immediate command. If the host has set the standby timer, the drive can also enter Standby mode automatically after the drive has been inactive for a specifiable length of time. The standby timer delay is established using a Standby or Idle command. In Standby mode, the drive buffer is in Self Refresh Low Power mode, the heads are parked and the spindle is at rest. The drive accepts all commands and returns to Active mode any time disc access is necessary.

Sleep mode

The drive enters Sleep mode after receiving a Sleep command from the host. In Sleep mode, the drive buffer is in Self Refresh Low Power mode, the heads are parked and the spindle is at rest. The drive leaves Sleep mode after it receives a Hard Reset or Soft Reset from the host. After receiving a reset, the drive exits Sleep mode and enters Standby mode with all current translation parameters intact.

Idle and Standby timers

Each time the drive performs an Active function (read, write or seek), the standby timer is reinitialized and begins counting down from its specified delay times to zero. If the standby timer reaches zero before any drive activity is required, the drive makes a transition to Standby mode. In both Idle and Standby mode, the drive accepts all commands and returns to Active mode when disc access is necessary.

2.10 Environmental specifications

2.10.1 Ambient temperature

Ambient temperature is defined as the temperature of the environment immediately surrounding the drive. Actual drive case temperature should not exceed 65°C (149°F) within the operating ambient conditions.

Above 1,000 feet (305 meters), the maximum temperature is derated linearly by 1°C every 1000 feet.

Operating	0° to 60°C (32° to 140°F)
Nonoperating	-40° to 70°C (-40° to 158°F)

2.10.2 Temperature gradient

Operating	20°C per hour (68°F per hour max), without condensation
Nonoperating	30°C per hour (86°F per hour max), without condensation

2.10.3 Humidity

2.10.3.1 Relative humidity

Operating	5% to 90% noncondensing (30% per hour max)
Nonoperating	5% to 95% noncondensing (30% per hour max)

2.10.3.2 Wet bulb temperature

Operating	30°C (86°F max)
Nonoperating	38°C (100.4°F max)

2.10.4 Altitude

Operating	-304.8 m to 3,048 m (-1,000 ft to 10,000 ft)
Nonoperating	-304.8 m to 12,192 m (-1,000 ft to 40,000 ft)

2.10.5 Shock

All shock specifications assume that the drive is mounted securely with the input shock applied at the drive mounting screws. Shock may be applied in the X, Y or Z axis.

2.10.5.1 Operating shock

These drives comply with the performance levels specified in this document when subjected to a maximum operating shock of 350 Gs based on half-sine shock pulses of 2 msec. Shocks should not be repeated more than two times per second.

2.10.5.2 Nonoperating shock

The nonoperating shock level that the drive can experience without incurring physical damage or degradation in performance when subsequently put into operation is 800 Gs based on a nonrepetitive half-sine shock pulse of 2 msec duration.

The nonoperating shock level that the drive can experience without incurring physical damage or degradation in performance when subsequently put into operation is 900 Gs based on a nonrepetitive half-sine shock pulse of 1 msec duration.

The nonoperating shock level that the drive can experience without incurring physical damage or degradation in performance when subsequently put into operation is 400 Gs based on a nonrepetitive half-sine shock pulse of 0.5 msec duration.

2.10.6 Vibration

All vibration specifications assume that the drive is mounted securely with the input vibration applied at the drive mounting screws. Vibration may be applied in the X, Y or Z axis.

2.10.6.1 Operating vibration

The following table lists the maximum vibration levels that the drive may experience while meeting the performance standards specified in this document.

5-500 Hz 1.0 Gs (0 to peak). Max displacement may apply below 10 Hz.	5–500 Hz	1.0 Gs (0 to peak). Max displacement may apply below 10 Hz.
--	----------	---

2.10.6.2 Nonoperating vibration

The following table lists the maximum nonoperating vibration that the drive may experience without incurring physical damage or degradation in performance when subsequently put into operation.

5–500 Hz	5.0 Gs (0 to peak). Max displacement may apply below 22 Hz.
----------	---

2.11 Acoustics

Drive acoustics are measured as overall A-weighted acoustic sound power levels (no pure tones). All measurements are consistent with ISO document 7779. Sound power measurements are taken under essentially free-field conditions over a reflecting plane. For all tests, the drive is oriented with the cover facing upward.

Note. For seek mode tests, the drive is placed in seek mode only. The number of seeks per second is defined by the following equation:

(Number of seeks per second = 0.4 / (average latency + average access time)

Table 4: Drive level acoustics

Models		Idle*	Normal Seek	Performance Seek
2 Discs	ST9160821A ST9120822A ST9100828A	2.4 bels (typ) 2.6 bels (max)	2.6 2.8	3.0 bels (typ) 3.2 bels (max)
1 Disc	ST980815A ST960815A ST940815A	2.2 bels (typ) 2.4 bels (max)	2.5 2.7	2.9 bels (typ) 3.1 bels (max)

^{*}During periods of drive idle, some offline activity may occur according to the S.M.A.R.T. specification, which may increase acoustic and power to operational levels.

2.12 Electromagnetic immunity

When properly installed in a representative host system, the drive operates without errors or degradation in performance when subjected to the rradio frequency (RF) environments defined in the following table:

Table 5: Electromagnetic immunity

Test	Description	Performance level	Reference standard
Electrostatic discharge	Contact, HCP, VCP: ± 4 kV; Air: ± 8 kV	В	EN 61000-4-2: 95
Radiated RF immunity	80 to 2,000 MHz, 10 V/m, 80% AM with 1 kHz sine 900 MHz, 3 V/m, 50% pulse modulation @ 200 Hz	A	EN 61000-4-3: 96 ENV 50204: 95
Electrical fast transient	± 1 kV on AC mains, ± 0.5 kV on external I/O	В	EN 61000-4-4: 95
Surge immunity	± 1 kV differential, ± 2 kV common, AC mains	В	EN 61000-4-5: 95
Conducted RF immunity	150 kHz to 80 MHz, 3 Vrms, 80% AM with 1 kHz sine	А	EN 61000-4-6: 97
Power Frequency H-field immunity	1 A/m, 50Hz/60Hz, 3 axes	А	EN 61000-4-8: 97
Voltage dips, interrupts	30% Reduction for 25 cycles >95% Reduction for 250 cycles >95%, 0.5 cycles	C C B	EN 61000-4-11: 94

A - 1) No upset or degradation in performance beyond manufacturer's specified limits.

²⁾ No data loss.

B - 1) Unit self recovers without user intervention.

²⁾ No data loss.

C - 1) Upset OK provided that unit will function after user intervention.

2.13 Reliability

Measurement type	Specification
Nonrecoverable read errors	1 per 10 ¹⁴ bits read, max.
Annualized Failure Rate (AFR)	<0.60%
Load/Unload (U/UL)	
25°C, 50% relative humidity	600,000 software-controlled power on/off cycles 20,000 hard power on/off cycles
32°C, 80% relative humidity 5°C, 80% relative humidity 5°C, 10% relative humidity 55°C, 16% relative humidity	600,000 software-controlled power on/off cycles 20,000 hard power on/off cycles
Warranty	5 years on distribution units.
	To determine the warranty for a specific drive, use a web browser to access the following web page:
	www.seagate.com/support/service/
	From this page, click on the "Verify Your Warranty" link. You will be asked to provide the drive serial number, model number (or part number) and country of purchase. The system will display the warranty information for your drive.

2.14 Agency certification

2.14.1 Safety certification

The drives are recognized in accordance with UL 1950 and CSA C22.2 (950) and meet all applicable sections of IEC950 and EN 60950 as tested by TUV North America.

2.14.2 Electromagnetic compatibility

Hard drives that display the CE mark comply with the European Union (EU) requirements specified in the Electromagnetic Compatibility Directive (89/336/EEC). Testing is performed to the levels specified by the product standards for Information Technology Equipment (ITE). Emission levels are defined by EN 55022, Class B and the immunity levels are defined by EN 55024.

Seagate uses an independent laboratory to confirm compliance with the EC directives specified in the previous paragraph. Drives are tested in representative end-user systems. Although CE-marked Seagate drives comply with the directives when used in the test systems, we cannot guarantee that all systems will comply with the directives. The drive is designed for operation inside a properly designed enclosure, with properly shielded I/O cable (if necessary) and terminators on all unused I/O ports. Computer manufacturers and system integrators should confirm EMC compliance and provide CE marking for their products.

Korean RRL

If these drives have the Korea Ministry of Information and Communication (MIC) logo, they comply with paragraph 1 of Article 11 of the Electromagnetic Compatibility control Regulation and meet the Electromagnetic Compatibility (EMC) Framework requirements of the Radio Research Laboratory (RRL) Ministry of Information and Communication Republic of Korea.

These drives have been tested and comply with the Electromagnetic Interference/Electromagnetic Susceptibility (EMI/EMS) for Class B products. Drives are tested in a representative, end-user system by a Korean-recognized lab.

EUT name (model numbers): ST9120822A, ST980815A, ST960815A, ST960815A, ST960815A, and ST940815A.

· Certificate numbers:

ST9160821A	STX-L253 (B)
ST9120822A	STX-L253 (B)
ST9100828A	STX-L253 (B)
ST980815A	STX-L253 (B)
ST960815A	STX-L253 (B)
ST940815A	STX-L253 (B)

- Trade name or applicant: Seagate Technology International
- · Manufacturing date: January 2006
- Manufacturer/nationality: Seagate Technology International

Australian C-Tick (N176)

If these models have the C-Tick marking, they comply with the Australia/New Zealand Standard AS/NZS3548 1995 and meet the Electromagnetic Compatibility (EMC) Framework requirements of the Australian Communication Authority (ACA).

2.14.3 FCC verification

These drives are intended to be contained solely within a personal computer or similar enclosure (not attached as an external device). As such, each drive is considered to be a subassembly even when it is individually marketed to the customer. As a subassembly, no Federal Communications Commission verification or certification of the device is required.

Seagate Technology LLC has tested this device in enclosures as described above to ensure that the total assembly (enclosure, disc drive, motherboard, power supply, etc.) does comply with the limits for a Class B computing device, pursuant to Subpart J, Part 15 of the FCC rules. Operation with noncertified assemblies is likely to result in interference to radio and television reception.

Radio and television interference. This equipment generates and uses radio frequency energy and if not installed and used in strict accordance with the manufacturer's instructions, may cause interference to radio and television reception.

This equipment is designed to provide reasonable protection against such interference in a residential installation. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause interference to radio or television, which can be determined by turning the equipment on and off, you are encouraged to try one or more of the following corrective measures:

- Reorient the receiving antenna.
- Move the device to one side or the other of the radio or TV.
- Move the device farther away from the radio or TV.
- Plug the computer into a different outlet so that the receiver and computer are on different branch outlets.

If necessary, you should consult your dealer or an experienced radio/television technician for additional suggestions. You may find helpful the following booklet prepared by the Federal Communications Commission: How to Identify and Resolve Radio-Television Interference Problems. This booklet is available from the Superintendent of Documents, U.S. Government Printing Office, Washington, DC 20402. Refer to publication number 004-000-00345-4.

2.15 Environmental protection

Seagate designs its products to meet environmental protection requirements worldwide, including regulations restricting certain chemical substances.

2.15.1 European Union Restriction of Hazardous Substances (RoHS)

The European Union Restriction of Hazardous Substances (RoHS) Directive restricts the presence of chemical substances, including Lead (Pb), in electronic products effective July 2006.

A number of parts and materials in Seagate products are procured from external suppliers. We rely on the rep-resentations of our suppliers regarding the presence of RoHS substances in these parts and materials. Our supplier contracts require compliance with our chemical substance restrictions, and our suppliers document their compliance with our requirements by providing material content declarations for all parts and materials for the disc drives documented in this publication. Current supplier declarations include disclosure of the inclusion of any RoHS-regulated substance in such parts or materials.

Seagate also has internal systems in place to ensure ongoing compliance with the RoHS Directive and all laws and regulations which restrict chemical content in electronic products. These systems include standard operating procedures that ensure that restricted substances are not utilized in our manufacturing operations, laboratory analytical validation testing, and an internal auditing process to ensure that all standard operating procedures are complied with.

2.16 Corrosive environment

Seagate electronic drive components pass accelerated corrosion testing equivalent to 10 years exposure to light industrial environments containing sulfurous gases, chlorine and nitric oxide, classes G and H per ASTM B845. However, this accelerated testing cannot duplicate every potential application environment. Users should use caution exposing any electronic components to uncontrolled chemical pollutants and corrosive chemicals as electronic drive component reliability can be affected by the installation environment. The silver, copper, nickel and gold films used in Seagate products are especially sensitive to the presence of sulfide, chloride, and nitrate contaminants. Sulfur is found to be the most damaging. In addition, electronic components should never be exposed to condensing water on the surface of the printed circuit board assembly (PCBA) or exposed to an ambient relative humidity greater than 95%. Materials used in cabinet fabrication, such as vulcanized rubber, that can outgas corrosive compounds should be minimized or eliminated. The useful life of any electronic equipment may be extended by replacing materials near circuitry with sulfide-free alternatives.

3.0 Configuring and mounting the drive

This section contains the specifications and instructions for configuring and mounting the drive.

3.1 Handling and static discharge precautions

After unpacking, and before installation, the drive may be exposed to potential handling and electrostatic discharge (ESD) hazards. Observe the following standard handling and static-discharge precautions:

Caution:

- Keep the drive in the electrostatic discharge (ESD) bag until you are ready for installation to limit the drive's exposure to ESD.
- Before handling the drive, put on a grounded wrist strap, or ground yourself frequently by touching the metal chassis of a computer that is plugged into a grounded outlet. Wear a grounded wrist strap throughout the entire installation procedure.
- Handle the drive only by its edges or frame.
- The drive is fragile—handle it with care. Do not press down on the drive top cover.
- Always rest the drive on a padded, antistatic surface until you mount it in the computer.
- Do not touch the connector pins or the printed circuit board.
- Do not remove the factory-installed labels from the drive or cover them with additional labels. Removal voids the warranty. Some factory-installed labels contain information needed to service the drive. Other labels are used to seal out dirt and contamination.

3.2 Jumper settings

3.2.1 Master/slave configuration

Use the options jumper block shown in Figure 5 to configure the drive for operation. This jumper block is the 4-pin header adjacent to pins 1 and 2 of the I/O signal pins. For additional information about using the Cable select option, see Section 3.2.2.

The "Master or single drive" option is the factory default setting.

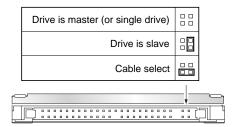


Figure 5. Jumper settings

3.2.2 Cable-select option

Computers that use cable select determine the master and slave drives by selecting or deselecting pin 28, CSEL, on the interface bus. Master and slave drives are determined by their physical position on the cable. To enable cable select, set a jumper as shown in Figure 5. Refer to your computer manual to determine whether your computer supports this option.

3.3 Drive mounting

You can mount the drive using four screws in the side-mounting holes or four screws in the bottom-mounting holes. See Figure 6 for drive mounting dimensions (dimensions in inches with mm in parentheses). Follow these important mounting precautions when mounting the drive:

- Allow a minimum clearance of 0.030 inches (0.76 mm) around the entire perimeter of the drive for cooling.
- Use only M3 x 0.5 mounting screws.
- Do not overtighten the mounting screws (maximum torque: 4.0 inch-lb).
- Four (4) threads (0.080 inches) minimum screw engagement recommended.

Measurements shown in Figure 6 are in inches.

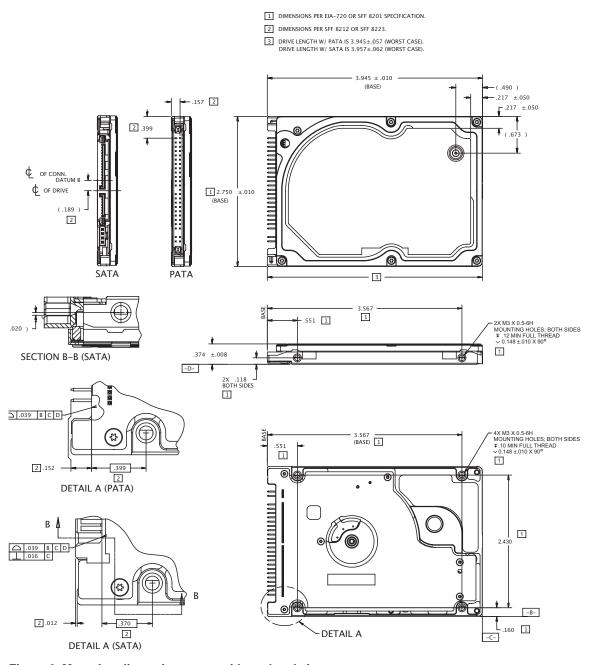


Figure 6. Mounting dimensions—top, side and end view

4.0 ATA interface

These drives use the industry-standard ATA task file interface that supports 16-bit data transfers. It supports ATA programmed input/output (PIO) modes 0–4; multiword DMA modes 0–2, and Ultra DMA modes 0–5. The drive also supports the use of the IORDY signal to provide reliable high-speed data transfers.

For detailed information about the ATA interface, refer to the draft of AT Attachment with Packet Interface Extension (ATA/ATAPI-6), NCITS T13 1410D, subsequently referred to as the Draft ATA-6 Standard.

4.1 ATA interface signals and connector pins

The following table summarizes the signals on the 44-pin ATA interface connector. For a detailed description of these signals, refer to the *Draft ATA-6 Standard*.

Table 6: Connector signals

Signal Name	Connector Contact	Cable Conductor
RESET-	1	1
DD7	3	3
DD6	5	5
DD5	7	7
DD4	9	9
DD3	11	11
DD2	13	13
DD1	15	15
DD0	17	17
Ground	19	19
DMARQ	21	21
DIOW-	23	23
DIOR-	25	25
IORDY	27	27
DMACK-	29	29
INTRQ	31	31
DA1	33	33
DA0	35	35
CS1FX-	37	37
DASP-	39	39
+5 V (Logic)	41	41
Ground (Return)	43	43

Cable Conductor	Connector Contact	Signal Name
2	2	Ground
4	4	DD8
6	6	DD9
8	8	DD10
10	10	DD11
12	12	DD12
14	14	DD13
16	16	DD14
18	18	DD15
20	20	(keypin)
22	22	Ground
24	24	Ground
26	26	Ground
28	28	PSYNC:CSEL
30	30	Ground
32	32	IOCS16-
34	34	PDIAG-
36	36	DA2
38	38	CS3FX-
40	40	Ground
42	42	+5V (Motor)
44	44	No connection

4.1.1 Supported ATA commands

The following table lists ATA-standard commands that the drive supports. For a detailed description of the ATA commands, refer to the *Draft ATA-6 Standard...*

Table 7: Supported commands

Command name	Command code (in hex)
ATA-standard commands	
ATA Device Configuration Overlay	B1 _H
ATA Service	A2 _H
Check Power Mode	98 _{H,} E5 _H
Download Microcode	92 _H
Execute Device Diagnostics	90 _H
Flush Cache	E7 _H
Flush Cache Extended	EA _H
Format Track (Legacy)	50 _H
Identify Device	EC _H
Idle	97 _{H,} E3 _H
Idle Immediate	95 _{H,} E1 _H
Initialize Device Parameters	91 _H
Read Buffer	E4 _H
Read DMA	C8 _{H,} C9 _H
Read DMA Extended	25 _H
Read Log Extended	22 _H
Read Multiple	C4 _H
Read Multiple Extended	29 _H
Read Native Max Address	F8 _H
Read Native Max Address Extended	27 _H
Read Sectors	20 _H , 21 _H
Read Sectors Extended	24 _H
Read Verify Sectors	40 _H , 41 _H
Read Verify Sectors Extended	42 _H
Recalibrate	10 _H
Security Disable Password	F6 _H
Security Erase Prepare	F3 _H
Security Erase Unit	F4 _H
Security Freeze Lock	F5 _H
Security Set Password	F1 _H
Security Unlock	F2 _H

Table 7: Supported commands

Command name	Command code (in hex)
Seek	70 _H
Set Drive Parameters	91 _H
Set Features	EF _H
Set Max Address	F9 _H
Note: Individual Set Max com- mands are identified by the value placed in the Set Max Features register as defined to the right.	Address 00 _H Password 01 _H Lock 02 _H Unlock 03 _H Freeze Lock 04 _H
Set Multiple Mode	C6 _H
Sleep	99 _{H,} E6 _H
S.M.A.R.T.	B0 _H
Standby	96 _H , E2 _H
Standby Immediate	94 _H , E0 _H
Vendor Unique	9A _H , FA _H , FB _H
Write Buffer	E8 _H
Write DMA	CA _{H,} CB _H
Write DMA Extended	35 _H
Write Log Extended	32 _H
Write Multiple	C5 _H
Write Multiple Extended	39 _H
Write Sectors	30 _H , 31 _H
Write Sectors Extended	34 _H
ATA-standard power-management co	ommands
Check Power Mode	98 _H or E5 _H
Idle	97 _H or E3 _H
Idle Immediate	95 _H or E1 _H
Sleep	99 _H or E6 _H
Standby	96 _H or E2 _H
Standby Immediate	94 _H or E0 _H
ATA-standard security commands	
Security Set Password	F1 _H
Security Unlock	F2 _H
Security Erase Prepare	F3 _H
Security Erase Unit	F4 _H
Security Freeze Lock	F5 _H

Table 7: Supported commands

Command name	Command code (in hex)
Security Disable Password	F6 _H

4.1.2 Identify Device command

The Identify Device command (command code EC_H) transfers information about the drive to the host following power up. The data is organized as a single 512-byte block of data, whose contents are shown in Table 7 on page 26. All reserved bits or words should be set to zero. Parameters listed with an "x" are drive-specific or vary with the state of the drive. See Section 2.0 on page 3 for default parameter settings.

The following commands contain drive-specific features that may not be included in the Draft ATA-6 Standard.

0		
	Configuration information: • Bit 15: 0 = ATA; 1 = ATAPI • Bit 7: removable media • Bit 6: removable controller • Bit 0: reserved	0C5A _H
1	Number of logical cylinders	16,383
2	ATA-reserved	0000 _H
3	Number of logical heads	16
4	Retired	0000 _H
5	Retired	0000 _H
6	Number of logical sectors per logical track: 63	003F _H
7–9	Retired	0000 _H
10–19	Serial number: (20 ASCII characters, 0000 _H = none)	ASCII
20	Retired	0000 _H
21	Retired	0400 _H
22	Obsolete	0000 _H
23–26	Firmware revision (8 ASCII character string, padded with blanks to end of string)	x.xx
27–46	Drive model number (40 ASCII characters, padded with blanks to end of string)	ST9160821A ST9120822A ST9100828A ST980815A ST960815A ST940815A
47	(Bits 7–0) Maximum sectors per interrupt on Read multiple and Write multiple (16)	8010 _H
48	Reserved	0000 _H
49	Standard Standby timer, IORDY supported and may be disabled	2F00 _H
50	ATA-reserved	0000 _H
51	PIO data-transfer cycle timing mode	0200 _H
52	Retired	0200 _H
53	Words 54–58, 64–70 and 88 are valid	0007 _H
54	Number of current logical cylinders	xxxx _H
55	Number of current logical heads	xxxx _H
56	Number of current logical sectors per logical track	xxxx _H

Word	Description	Value
57–58	Current capacity in sectors	xxxx _H
59	Number of sectors transferred during a Read Multiple or Write Multiple command	xxxx _H
60–61	Total number of user-addressable LBA sectors available (see Section 2.2 for related information)	ST9160821A = 312,581,808 ST9120822A = 234,441,648 ST9100828A = 195,371,568 ST980815A = 156,301,488 ST960815A = 117,410,240 ST940815A = 78,140,160
62	Retired	0000 _H
63	Multiword DMA active and modes supported (see note following this table)	<i>xx</i> 07 _H
64	Advanced PIO modes supported (modes 3 and 4 supported)	0003 _H
65	Minimum multiword DMA transfer cycle time per word (120 nsec)	0078 _H
66	Recommended multiword DMA transfer cycle time per word (120 nsec)	0078 _H
67	Minimum PIO cycle time without IORDY flow control (240 nsec)	00F0 _H
68	Minimum PIO cycle time with IORDY flow control (120 nsec)	0078 _H
69–74	ATA-reserved	0000 _H
75	Queue depth	0000 _H
76–79	ATA-reserved	0000 _H
80	Major version number	007E _H
81	Minor version number	0000 _H
82	Command sets supported	346B _H
83	Command sets supported	7D01 _H
84	Command sets support extension	4003 _H
85	Command sets enabled	34 <i>xx</i> _H
86	Command sets enabled	3xxx _H
87	Command sets enable extension	4003 _H
88	Ultra DMA support and current mode (see note following this table)	xx3F _H
89	Security erase time	0000 _H
90	Enhanced security erase time	0000 _H
91	Advanced power management value	0040 _H
92	Master password revision code	FFFE _H
93	Hardware reset value (see description following this table)	xxxx _H
94	Auto acoustic management setting	xxxx _H
95–127	ATA-reserved	0000 _H
128	Security status	0001 _H

Word	Description	Value
129–159	Seagate-reserved	xxxx _H
160–254	ATA-reserved	0000 _H
255	Integrity word	xxA5 _H

Note. See the bit descriptions below for words 63, 88, 93 and 94 of the Identify Drive data.

Description (if bit is set to 1)

Bit	Word 63
0	Multiword DMA mode 0 is supported.
1	Multiword DMA mode 1 is supported.
2	Multiword DMA mode 2 is supported.
8	Multiword DMA mode 0 is currently active.
9	Multiword DMA mode 1 is currently active.
10	Multiword DMA mode 2 is currently active.
Bit	Word 88
0	Ultra DMA mode 0 is supported.
1	Ultra DMA mode 1 is supported.
2	Ultra DMA mode 2 is supported.
3	Ultra DMA mode 3 is supported.
4	Ultra DMA mode 4 is supported.
8	Ultra DMA mode 0 is currently active.
9	Ultra DMA mode 1 is currently active.
10	Ultra DMA mode 2 is currently active.
11	Ultra DMA mode 3 is currently active.
12	Ultra DMA mode 4 is currently active.
13	Ultra DMA mode 5 is currently active.
Bit	Word 93
13	1 = 80-conductor cable detected, CBLID above V _{IH} 0 = 40-conductor cable detected, CBLID below V _{IL}

4.1.3 Set Features command

This command controls the implementation of various features that the drive supports. When the drive receives this command, it sets BSY, checks the contents of the Features register, clears BSY and generates an interrupt. If the value in the register does not represent a feature that the drive supports, the command is aborted. Power-on default has the read look-ahead and write caching features enabled. The acceptable values for the Features register are defined as follows:

Table 8: Features register values

02 _H	Enable write cache (default).		
03 _H	Set transfer mode (based on value in Sector Count register). Sector Count register values:		
	00 _H Set PIO mode to default (PIO mode 2).		
	01 _H	Set PIO mode to default and disable IORDY (PIO mode 2).	
	08 _H	PIO mode 0	
	09 _H	PIO mode 1	
	0A _H	PIO mode 2	
	0B _H	PIO mode 3	
	0C _H	PIO mode 4 (default)	
	20 _H	Multiword DMA mode 0	
	21 _H	Multiword DMA mode 1	
	22 _H	Multiword DMA mode 2	
	40 _H	Ultra DMA mode 0	
	41 _H	Ultra DMA mode 1	
	42 _H	Ultra DMA mode 2	
	43 _H	Ultra DMA mode 3	
	44 _H	Ultra DMA mode 4	
	45 _H	Ultra DMA mode 5	
05 _H	Enable advanced power management		
55 _H	Disable read look-ahead (read cache) feature.		
82 _H	Disable write cache.		
AA _H	Enable read look-ahead (read cache) feature (default).		
F1 _H	Report full capacity available		

Note. At power-on or after a hardware or software reset the default values of the features are as indicated above.

5.0 Compatibility summary

5.1 Installation considerations

Many of today's mobile computers have been designed to make it possible for the end user to replace the hard drive. Refer to your system's user manual for the location of the hard drive compartment and the specific instructions regarding replacement. Refer to your system manufacturer's support website for the most up-to-date information. Read and follow all instructions regarding the proper steps to be taken when replacing the system hard drive. Some mobile systems are sealed and require specialized tools to gain access to the hard drive. Special training or tools may be needed to service some mobile computers. In some cases, opening the case may void your warranty. Consult your system documentation. Seagate recommends taking your system to an authorized service technician to replace your hard drive.

System Compatibility

Seagate Product Assurance has tested Momentus drives in the systems listed in Table 9. Testing included multiple BIOS versions and operating systems. This testing was done to demonstrate compatibility with various hardware and software configurations. Hardware and software combinations, other than those tested, may also be compatible with this drive.

Table 9: Tested systems

Gateway 300SE **EVO D300** Gateway 450RGH EVO D300V Gateway 500XL EVO D310 Gateway 700S EVO D310M Gateway 700X EVO D310V ABIT BL7 **EVO D500** Acer Aspire 2000 EVO D500M Amilio EVO D500S ASUS P4SGL-VM **EVO D510** AZZA P4X2-AV EVO D510 SFF Bonatti EVO D510C Brasilia **EVO E-6000** Client Pro 345 EVO N620C Client Pro 345E **EVO W-4000** Compaq NX9500 FID 2040 Compaq D315 FID 2100 HP D330 FMV 16C/V HP D330 MT FMV Biblo MG 75HT/ST **HP D330 UT** FMV Biblo NB75H/T **HP D530** FMV Biblo NH90H/T HP D530 CMT FMV CE50G7 (IVY6) HP D530 SFF FMV NB18C HP D530 USDT Gigabyte GA-7DXR+ Dimensio GX400 Gigabyte GA-8IDX Dimension 4100 Gigabyte GA-8SIML Dimension 4100 XPSZ Gigabyte GA-8SR533 Dimension 4400 HP/Compaq NX7000 Dimension 4500S IBM XNote Dimension 4600 Imedia 7150(Discovery) Dimension 8100 Inspirion 8100 Inspirion 1150 Dimension 8200 Dimension 8250 Inspirion 2650 Dimension 8300 Inspirion 300M Dimension XPS Inspirion 5100 Dynabook TX/2513CMCW Inspirion 5150 Compaq E -6000 Inspirion 600M Gateway E Series Inspirion 8600 Gateway E-2000 Inspirion 9100 Gateway E-4000 Inspirion XPS Gateway E-4100 Intel 845GBV Gateway E4600 Intel SPRINGDALE-G Gateway E6000 Intellistation EPVO Gateway E-6100 Intellistation M PRO Elite ECS-K7S6A JIA HE H150 Flite FCS-I 4S5MG Latitude 100L Elite K7S5A Latitude 8600 Equium 3140CS Latitude D400 Equium 3150 Latitude D505 Equium 5070CS Latitude D600 ES2 300X Latitude D800 ES2 500S Latitude X300

Lavie LJ700/7F Lavie LL750/8 Lavie LL970/9D Lavie LR700/9E Lavie LS830/9D Microstar MSI-6561 Microstar MSI-6566E Millennia 920I PRO MIM 2020 MIT-RHE-BT Netvista Optiplex GX150 Optiplex GX260 Optiplex GX400 Pavillion 774Y Pavillion ZD7000 Pavillion ZT3000 Pavillion ZV5000 Pavillion ZX5000 Sony PCV-RZ60 Performance Performance 1400 Performance 1500 Powerbook 5 Powerbook 5.2 Powerbook 5,2 Powerbook G4 Precision 330 Precision 340 Precision 350 Precision 360 Precision 530 Precision M60 Presario 2100 Presario 2500 Presario 6000 Presario 8000 Presario 8000Z Presario R3000 Presario X1000 Pro S P4-1300SE Pro S P4-1400 Qosmio E10/1JCDT IBM R50 IBM R50P SB-4100A SB-4100-C SB-4100-E SB-4100-B Shuttle AV40 Slotek SL-85SD Scnic

Micron T2000 Micron T2100 Micron T2200 Thinkpad Thinkpad A22E ThinkpadG40 Thinkpad T30 Thinkpad T40 Tian YI S180 Transport GX3 Transport T1000 Transport V1000 Travel Mate 660 Travel Mate 800LCI Travel Mate 800LCI Travel Mate 2500 Travel Mate 290VCI Travel Mate 650 Travel Mate 660 Travel Mate 800 Travel Mate 8000 Trigem S7 7570 Trigem V7 7600 **NECUNI-TRI-NT** Micron V2000 Vaio PCG-V505/B Vaio PCG-ZIR/P Vaio PCV RX770 Vaio PCV7753 Vaio PCV-7753 Valuestar VC300/4D Valuestar VF500/8D Valuestar VF500/D Valuestar VG17H/8 Valuestar VG17H2Z38 Valuestar VT500/4D Veriton 7200D Veriton 7500 VGN-A70P W 6000 Workstation XW5000 Workstation XW8000 Presario X1000 MPC X3000 Yi He A760D Zhao Yang E260 Zhao Yang E600A Zhao Yang S620

ESX-SB-400 E PC

ESX500S

5.2 BIOS versions tested

The following list indicates the types of BIOS Seagate tested during the compatibility testing process. The list highlights the major BIOS manufacturers. Individual systems contain variations of these BIOS versions and were tested with regard to their implementation in the individual systems.

Table 10: Tested BIOS versions

Vendor	Release	Revision
ACER		1.01
ACPI		Ver. 1.20
AMI	Various	Various
Apple	4.71F1	
Apple	4.8.4F1	
Award	Various	Various
Compal	38118	v2.00
Compaq	68xxx	Various
Compaq	78xxx	Various
Compaq	8602	v1.08
Compaq	F.07	
Dell	Various	A03
Gateway	Various	
HP	Various	Various
IBM	Various	Various
Insyde SCU		1.1
Insyde	Various	Various
Insyde	Mobilepro	Various
Intel	786B2	v1.11
M1300	A02	37763
Medion	1.0D-1373-0812	
Micron	Various	
Mobile Pro	4.00.01	V1.04 EC1.01M
NEC	Various	Various
Phoenix	Various	Various
Toshiba	Various	Various

5.3 Operating system versions tested

This list indicates the types of Operating Systems Seagate tested during the compatibility testing process and highlights the major OS manufacturers. Several variations of the major operating systems have been tested.

Table 11: Operating systems tested

Manufacturer	Version/Release
Apple	MacOS 9.22
Apple	MacOS X 10.2.3
Microsoft	MSDOS 6.22
Microsoft	Windows 98, 98SE, ME (multiple languages)
Microsoft	Windows 2000, 2000-Pro (+SP 1 thru 4) (multiple languages)
Microsoft	Windows NT 4.0 (+SP 6 and 6a) (+Japanese)
Microsoft	Windows XP, XP Pro, XP Home (+SP1) (multiple languages)

5.4 Compatibility test configurations

The Momentus drives have been tested to demonstrate compliance with ATA/ATAPI-6 in both the master drive and slave drive positions. These tests were preformed to ensure the functionality to ATA/ATAPI-6 specifications and the compatibility of Seagate Momentus drives with other ATA/ATAPI-6 compliant peripherals.

5.5 Software utilities

The following is a brief overview of a some of the Seagate utilities used during the Seagate competitive analysis process.

The Seagate SeaTools application is an exclusive disc drive diagnostic software designed to troubleshoot most hard drive issues. Desktop edition works with most ATA, SATA, or SCSI drives in desktop systems and has a 98 percent accuracy rate.

The Seagate DiscWizard[™] application simplifies the installation of disc drives. This software also overcomes many system BIOS and operating system limitations that can complicate the installation of higher-capacity ATA (IDE) interface drives.

This is a list of some of the third party utilities used in the testing process.

Vendor	Application
AMI	Diagnostic
Apple	Macbench
Intel	PCI-EXE
Microsoft	Winbench99
Symantec	Norton Utilities

5.6 Other certification

Microsoft software compatibility.

6.0 Seagate Technology support services

Internet

For information regarding Seagate products and services, visit <u>www.seagate.com</u>. Worldwide support is available 24 hours daily by email for your questions.

Presales Support:

Presales@Seagate.com

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http://www.seagate.com/support/service/index.html

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Seagate Service Centers

Presales Support

Our Presales Support staff can help you determine which Seagate products are best suited for your specific application or computer system, as well as product availability and compatibility.

Technical Support

Seagate technical support is available to assist you online at <u>support.seagate.com</u> or through one of our call centers. Have your system configuration information and your "ST" model number available.

SeaTDD[™] **(+1-405-324-3655)** is a telecommunications device for the deaf (TDD). You can send questions or comments 24 hours daily and exchange messages with a technical support specialist during normal business hours for the call center in your region.

Customer Service Operations

Warranty Service

Seagate offers worldwide customer support for Seagate products. Seagate distributors, OEMs and other direct customers should contact their Seagate Customer Service Operations (CSO) representative for warranty-related issues. Resellers or end users of drive products should contact their place of purchase or Seagate warranty service for assistance. Have your serial number and model or part number available.

Data Recovery Services

Seagate offers data recovery services for all formats and all brands of storage media. Our data recovery services labs are currently located throughout the world. Additional information, including an online request form and data loss prevention resources, is available at http://services.seagate.com/index.aspx

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For an extensive list of telephone numbers to technical support, presales and warranty service in USA/ Canada/Latin America, including business hours, go to the "Contact Us" page on www.seagate.com.

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and Mexico 1-800-SEAGATE +1-405-324-4700

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